March 2006



FSUSB31 Low Power Dual SPST Hi-Speed USB 2.0 (480Mbps) Switch

Features

- Low On capacitance, 6.0pF (typical)
- Low On resistance, 6.5Ω (typical)
- Low power consumption (1µA maximum)
- 10µA maximum ICCT over and expanded control voltage range (V_{IN}=2.6V, V_{CC}=4.3V)
- Wide -3dB bandwidth, > 720MHz
- 8K I/O to GND ESD protection
- Power OFF protection when V_{CC} = 0V, D+/D- pins can tolerate up to 4.3V
- Packaged in:
 - Pb-Free 8-lead MicroPak[™] (1.6mm x 1.6mm)
 - Pb-Free 8-lead US-8 (preliminary)

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-top Box

General Description

The FSUSB30 is a Low Power, Dual SPST 2-Port Hi-Speed USB 2.0 switch. This part is configured as a single pole, single throw switch and is optimized for switching or isolating a Hi-Speed (480Mbps) source or a Hi-Speed and Full Speed (12Mbps) source. The FSUSB31 is compatible with the requirements of USB2.0 and features an extremely low On Capacitance (C_{ON}) of 6.0pF. The wide bandwidth of this device (>720MHz), exceeds the bandwidth needed to pass the 3rd harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

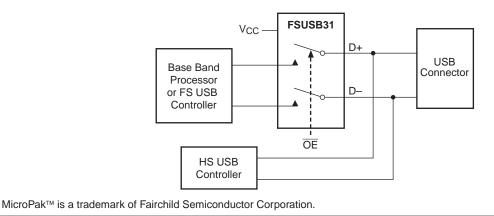
The FSUSB31 contains special circuitry on the D+/Dpins which allows the device to withstand an overvoltage condition. This device is also designed to minimize current consumption even when the control voltage applied to the \overline{OE} pin, is lower than the supply voltage (V_{CC}). This feature is especially valuable to Ultra-Portable applications such as cell phones, allowing for direct interface with the General Purpose I/Os of the baseband processor. Other applications include port isolation and switching in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

Ordering Information

| Order Number | Package Number | Package Description |
|--------------------------|----------------|---|
| FSUSB31K8X (Preliminary) | MAB08A | Pb-Free 8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide |
| FSUSB31L8X | MAC08A | Pb-Free 8-Lead MicroPak, 1.6 mm Wide |

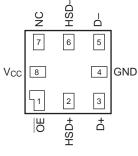
Pb-Free package per JEDEC J-STD-020B.

Application Diagram

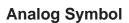


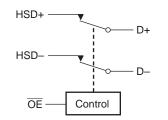
Connection Diagrams

Pad Assignments for MicroPak



(Top View)

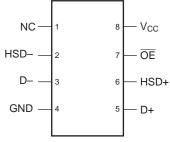




Pin Descriptions

| Pin Name | Description |
|--------------------|-------------------|
| ŌĒ | Bus Switch Enable |
| D+, D–, HSD+, HSD– | Data Ports |
| NC | No Connect |

Pin Assignment for US8



(Top Through View)

Truth Table

| ŌĒ | Function | | | | |
|----|--------------|--|--|--|--|
| Н | Disconnect | | | | |
| L | D+, D– = HSD | | | | |

Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.)

| Symbol | Parameter | Rating |
|-----------------|----------------------------------|---------------------------------|
| V _{CC} | Supply Voltage | -0.5V to +4.6V |
| V _S | DC Input Voltage ⁽¹⁾ | -0.5V to +4.6V |
| V _{IN} | DC Switch Voltage ⁽¹⁾ | |
| | HSD | –0.5V to V _{CC} + 0.3V |
| | D+, D- | -0.5V to +4.6V |
| | DC Input Diode Current | –50mA |
| | DC Output Current | 50mA |
| | Storage Temperature | –65°C to +150°C |
| | ESD (Human Body Model) | |
| | All Pins | 7.5kV |
| | I/O to GND | 8kV |

Recommended Operating Conditions⁽²⁾

| Symbol | Parameter | Rating |
|-----------------|-----------------------|-----------------------|
| V _{CC} | Supply Voltage | 3.0V to 4.3V |
| V _{IN} | Control Input Voltage | 0V to V _{CC} |
| | Switch Input Voltage | 0V to V _{CC} |
| | Operating Temperature | –40°C to +85°C |

Notes:

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed. DC switch voltage may never exceed 4.6V.

2. Control input must be held HIGH or LOW and it must not float.

DC Electrical Characteristics

(All typical values are @ 25°C unless otherwise specified.)

| | | | | T _A = - | +85°C | | |
|--------------------------|--|---|-------------|--------------------|-------|------|-------|
| Symbol | Parameter | Conditions | $V_{CC}(V)$ | Min | Тур | Max | Units |
| V _{IK} | Clamp Diode Voltage | I _{IN} = -18mA | 3.0 | | | -1.2 | V |
| V _{IH} | Input Voltage HIGH | | 3.0 to 3.6 | 1.3 | | | V |
| | | | 4.3 | 1.7 | | | |
| V _{IL} | Input Voltage LOW | | 3.0 to 3.6 | | | 0.5 | V |
| | | | 4.3 | | | 0.7 | |
| I _{IN} | Control Input Leakage | $V_{IN} = 0V \text{ to } V_{CC}$ | 4.3 | -1.0 | | 1.0 | μΑ |
| I _{OZ} | OFF State Leakage | $0 \le HSD \le V_{CC}$ | 4.3 | -2.0 | | 2.0 | μΑ |
| I _{OFF} | Power OFF Leakage Current (D+, D–) | $V_{IN} = 0.0V$ to 4.3V, $V_{CC} = 0V$ | 0 | -2.0 | | 2.0 | μΑ |
| R _{ON} | Switch On Resistance ³ | $V_{IN} = 0.4V, I_{ON} = -8mA$ | 3.0 | | 6.5 | 10.0 | Ω |
| ΔR_{ON} | Delta R _{ON} ⁴ | $V_{IN} = 0.4V, I_{ON} = -8mA$ | 3.0 | | 0.35 | | Ω |
| R _{ON} Flatness | R _{ON} Flatness ³ | $V_{IN} = 0.0V - 1.0V,$ $I_{ON} = -8mA$ | 3.0 | | 2.0 | | Ω |
| I _{CC} | Quiescent Supply Current | $V_{IN} = 0.0V \text{ or } V_{CC}, \ I_{OUT} = 0$ | 4.3 | | | 1.0 | μΑ |
| ICCT | Increase in I_{CC} Current per Control Voltage and V_{CC} Levels | V _{IN} = 2.6V, V _{CC} = 4.3V | 4.3 | | | 10.0 | μΑ |

AC Electrical Characteristics

(All typical values are for V_{CC} = 3.3V @ 25°C unless otherwise specified.)

| | | | | T _A = - | 40°C to | +85°C | | Figure |
|------------------|-----------------------------------|--|---------------------|--------------------|---------|-------|-------|----------------------|
| Symbol | Parameter | Conditions | V _{CC} (V) | Min | Тур | Max | Units | Number |
| t _{ON} | Turn On Time, OE to Output | $V_{IN} = 0.8V, R_L = 50\Omega,$ $C_L = 5pF$ | 3.0 to 3.6 | | 15.0 | 30.0 | ns | Figure 8 |
| t _{OFF} | Turn OFF Time. OE to Output | $V_{\text{IN}} = 0.8 \text{V}, \text{ R}_{\text{L}} = 50 \Omega,$ $C_{\text{L}} = 5 \text{pF}$ | 3.0 to 3.6 | | 12.0 | 25.0 | ns | Figure 8 |
| t _{PD} | Propagation Delay ⁴ | $R_L = 50\Omega, C_L = 5pF$ | 3.3 | | 0.25 | | ns | Figure 6 Figure 7 |
| Т _{ВВМ} | Break-Before-Make | $ \begin{array}{l} R_{L} = 50\Omega, \ C_{L} = 5pF, \\ V_{IN} = 0.8V \end{array} $ | 3.0 to 3.6 | 2.0 | | 6.5 | ns | Figure 9 |
| O _{IRR} | OFF Isolation (Non-Adjacent) | $R_{T} = 50\Omega$, f = 240MHz | 3.0 to 3.6 | | -35.0 | | dB | Figure 12 |
| Xtalk | Non-Adjacent Channel Crosstalk | $R_T = 50\Omega$, f = 240MHz | 3.0 to 3.6 | | -55.0 | | dB | Figure 13 |
| BW | -3dB Bandwidth | $R_T = 50\Omega, C_L = 0pF$ | 3.0 to 3.6 | | 720 | | MHz | Figure 11 |
| | | $R_T = 50\Omega, C_L = 5pF$ | 1 | | 550 | | | |

Notes:

3. Measured by the voltage drop between Dn, HSD, Dn pins at the indicated current through the switch. On Resistance is determined by the lower of the voltage on the two ports.

4. Guaranteed by characterization.

USB Hi-Speed Related AC Electrical Characteristics

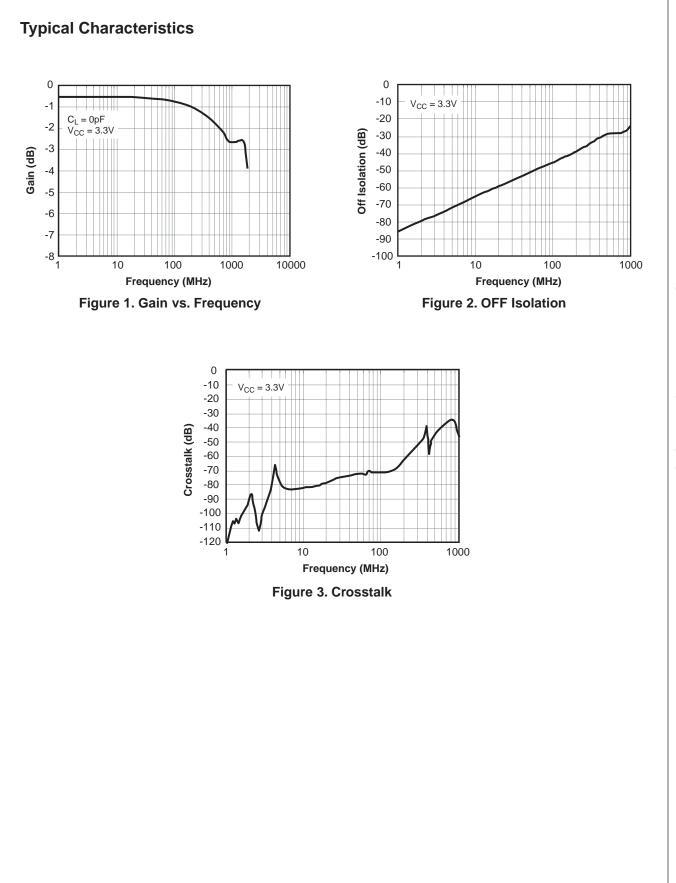
| Symbol | Parameter | Conditions | V _{CC} (V) | $T_A = -4$ | 40°C to | Units | Figure | |
|--------------------|--|---|---------------------|------------|---------|-------|--------|-----------------------|
| | i alameter | Conditions | • 66 (•) | Min | Тур | Мах | Units | Number |
| t _{SK(O)} | Channel-to-Channel Skew ⁵ | C _L = 5pF | 3.0 to 3.6 | | 50.0 | | ps | Figure 6 Figure 10 |
| t _{SK(P)} | Skew of Opposite Transitions of the Same Output ⁵ | C _L = 5pF | 3.0 to 3.6 | | 20.0 | | ps | Figure 6 Figure 10 |
| t _J | Total Jitter ⁵ | $R_L = 50\Omega, C_L = 5pF,$ $t_R = t_F = 500ps at 480 Mbps$ (PRBS = 2 ¹⁵ - 1) | 3.0 to 3.6 | | 200 | | ps | |

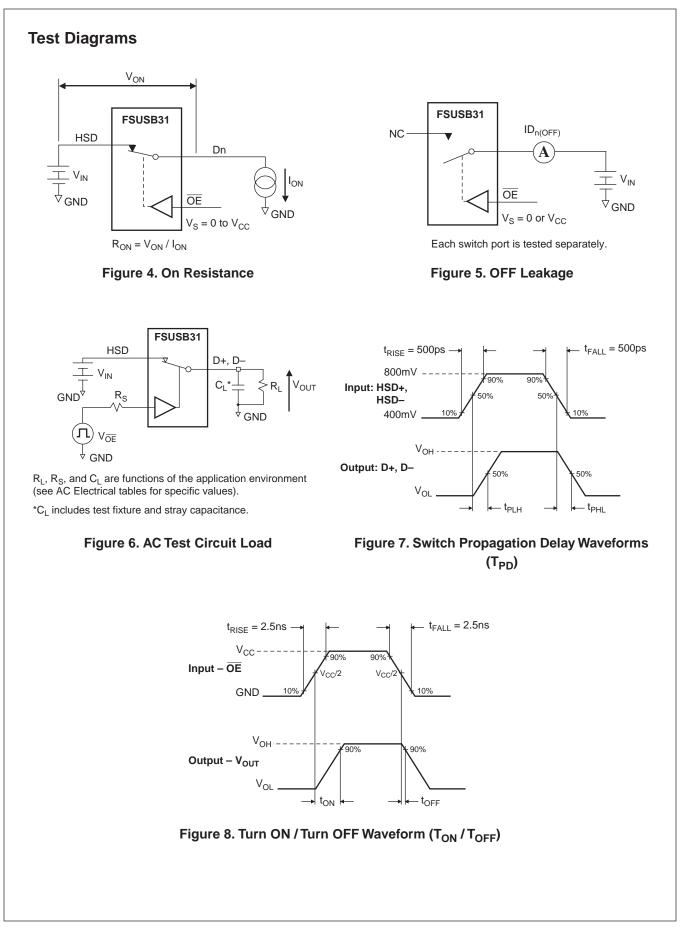
Notes:

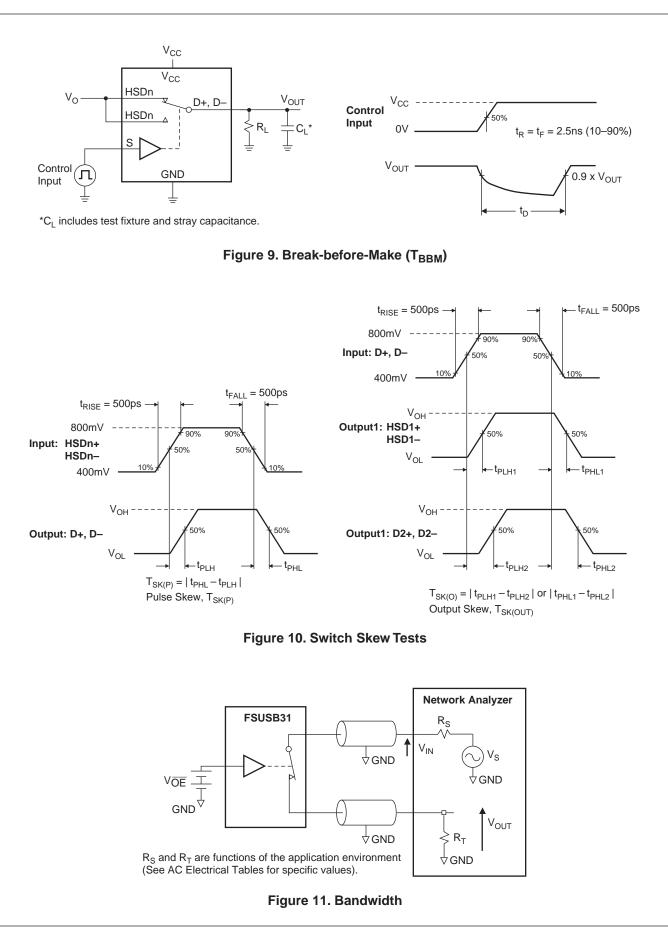
5. Guaranteed by design.

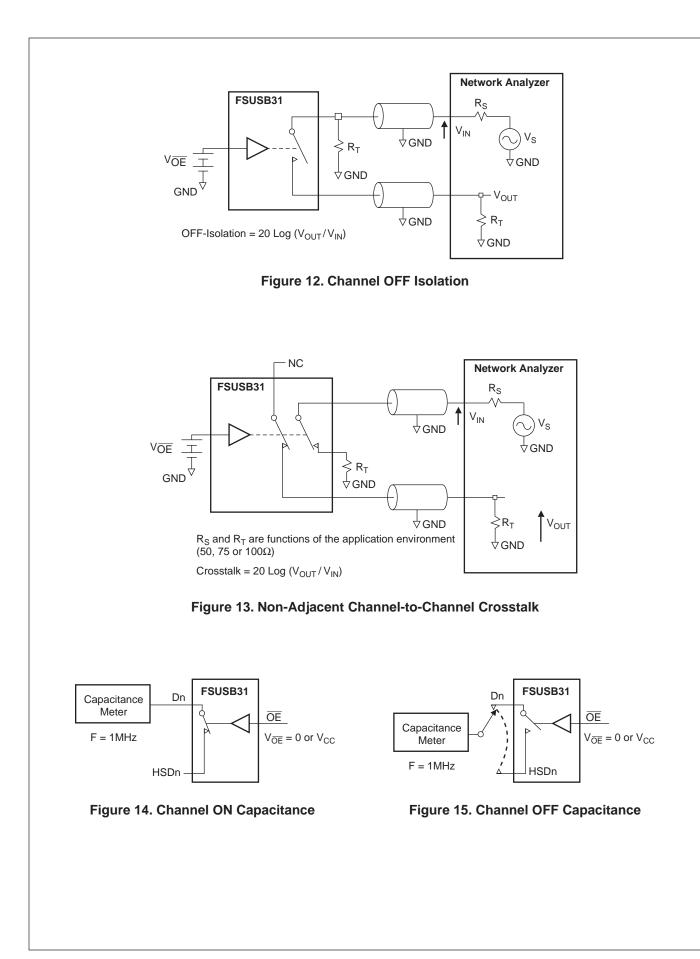
Capacitance

| Symbol | Parameter | Conditions | T _A = - | 40°C to | Units | Figure | |
|------------------|---|------------------------------------|--------------------|---------|-------|--------|-----------|
| Symbol | i arameter | Conditions | Min | Тур | Max | Units | Number |
| C _{IN} | Control Pin Input Capacitance | $V_{CC} = 0V$ | | 1.0 | | pF | Figure 15 |
| C _{ON} | D1 _n , D2 _n , Dn ON Capacitance | $V_{CC} = 3.3, \overline{OE} = 0V$ | | 6.0 | | pF | Figure 14 |
| C _{OFF} | D1 _n , D2 _n OFF Capacitance | V_{CC} and $\overline{OE} = 3.3$ | | 1.7 | | pF | Figure 15 |









Tape and Reel Specification

Tape Format for MircoPak

| Package Designator | Tape Section | Number Cavities | Cavity Status | Cover Tape Status |
|-----------------------|--------------------|--------------------|------------------|----------------------|
| L8X | Leader (Start End) | 125 (typ) | Empty | Sealed |
| | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (typ) | Empty | Sealed |

Tape Dimension inches (millimeters)

300038

300033

Ø

БĘ

SCALE: 6X

Q

Q

Æ₽

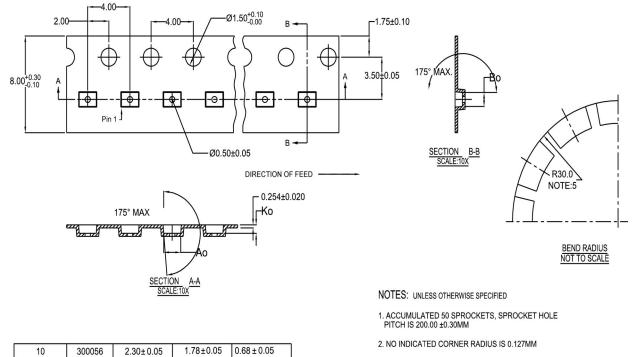
8 6

ふ

 1.78 ± 0.05

 1.60 ± 0.05

0



1.78±0.05

 1.15 ± 0.05

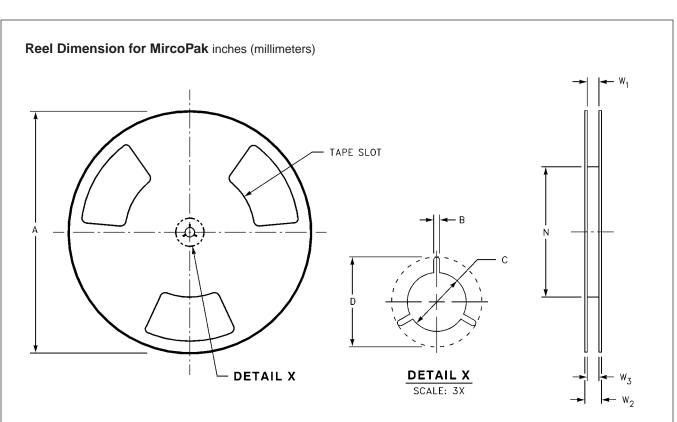
 0.68 ± 0.05

 0.70 ± 0.05

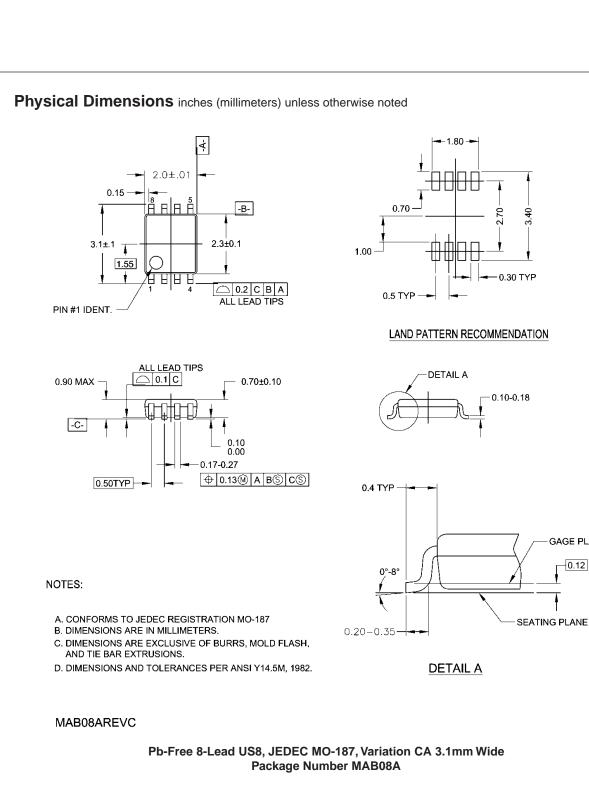
| 3. CAMBER | NOT TO EXCEED | 1MM IN 100MM |
|-----------|---------------|--------------|
| | | |

4. SMALLEST ALLOWABLE BENDING RADIUS

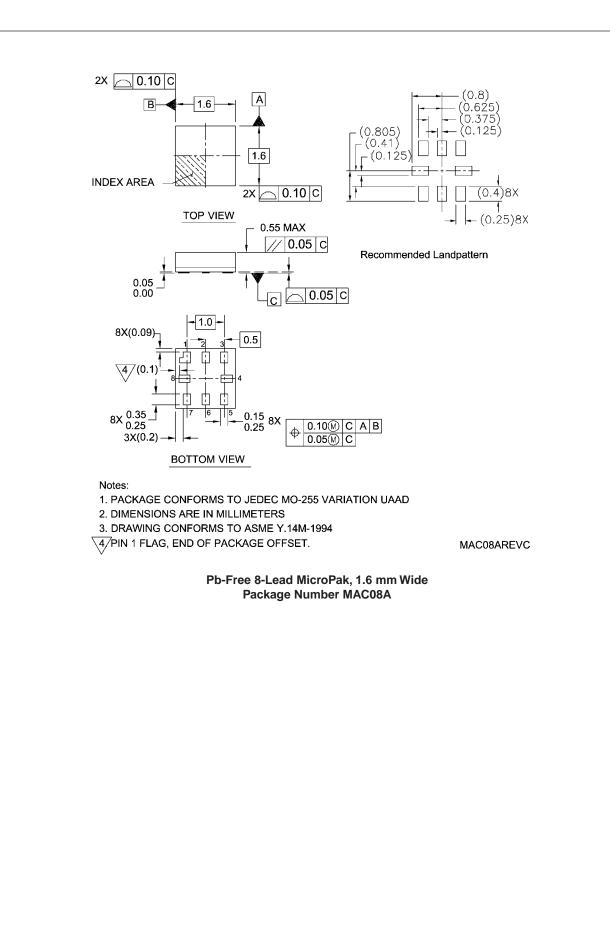
5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE



| Tape Size | Α | В | С | D | Ν | W1 | W2 | W3 |
|-----------|---------|--------|---------|---------|---------|----------------------|---------|-------------------|
| 8 mm | 7.0 | 0.059 | 0.512 | 0.795 | 2.165 | 0.331 + 0.059/-0.000 | 0.567 | W1 + 0.078/-0.039 |
| | (177.8) | (1.50) | (13.00) | (20.20) | (55.00) | (8.40 + 1.50/-0.00) | (14.40) | (W1 + 2.00/-1.00) |



GAGE PLANE 0.12



TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| ACEx™ | FAST® | ISOPLANAR™ | PowerSaver™ | SuperSOT™-6 |
|--|--------------------------------|---------------|---------------------------------|-----------------------|
| ActiveArray™ | FASTr™ | LittleFET™ | PowerTrench [®] | SuperSOT™-8 |
| Bottomless™ | FPS™ | MICROCOUPLER™ | QFET [®] | SyncFET™ |
| Build it Now™ | FRFET™ | MicroFET™ | QS™ | TCM™ |
| CoolFET™ | GlobalOptoisolator™ | MicroPak™ | QT Optoelectronics [™] | TinyLogic® |
| CROSSVOLT™ | GTO™ | MICROWIRE™ | Quiet Series™ | TINYOPTO™ |
| DOME™ | HiSeC™ | MSX™ | RapidConfigure™ | TruTranslation™ |
| EcoSPARK™ | I²C™ | MSXPro™ | RapidConnect™ | UHC™ |
| E ² CMOS™ | i-Lo™ | OCX™ | µSerDes™ | UltraFET [®] |
| EnSigna™ | ImpliedDisconnect [™] | OCXPro™ | ScalarPump™ | UniFET™ |
| FACT™ | IntelliMAX™ | OPTOLOGIC® | SILENT SWITCHER [®] | VCX™ |
| FACT Quiet Series™ | | OPTOPLANAR™ | SMART START™ | Wire™ |
| Across the board. Around the world. [™] The Power Franchise [®] Programmable Active Droop [™] | | PACMAN™ | SPM™ | |
| | | POP™ | Stealth™ | |
| | | Power247™ | SuperFET™ | |
| | | PowerEdge™ | SuperSOT™-3 | |

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILDÍS PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|---------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |